

CGD982HCI

1 GHz, 22 dB gain GaAs high output power doubler

Rev. 1 — 3 March 2011

Product data sheet

1. Product profile

1.1 General description

Hybrid amplifier module in a SOT115J package, operating at a supply voltage of 24 V Direct Current (DC), employing Hetero junction Field Effect Transistor (HFET) GaAs dies.

1.2 Features and benefits

- Excellent linearity
- Optimized for flat PAL D and flat NTSC loading
- Superior levels of ESD protection
- Extremely low noise
- Excellent return loss properties
- Gain compensation over temperature
- Rugged construction
- Unconditionally stable
- Thermally optimized design
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)
- Integrated ring wave surge protection

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1.3 Applications

- CATV systems operating in the 40 MHz to 862 MHz / 1003 MHz frequency range using PAL D or NTSC channel conditions.

1.4 Quick reference data

Table 1. Quick reference data

Bandwidth 40 MHz to 1003 MHz; $V_B = 24$ V (DC); $Z_S = Z_L = 75$ Ω ; $T_{mb} = 35$ $^{\circ}\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$f = 50$ MHz	-	21.5	-	dB
		$f = 1003$ MHz	22	23	24	dB
CTB	composite triple beat	$V_o = 48$ dBmV at 862 MHz	[1]	-	-66	-62 dBc
CSO	composite second-order distortion	$V_o = 48$ dBmV at 862 MHz	[1]	-	-69	-62 dBc
I_{tot}	total current		[2]	-	440	460 mA

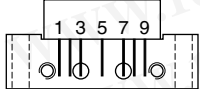
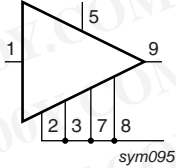
[1] 98 PAL D channels with 8 MHz bandwidth per channel; [$f = 47$ MHz to 862 MHz]; flat V_o till 862 MHz.

[2] Direct Current (DC).



2. Pinning information

Table 2. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	input		
2, 3	common		
5	+V _B		
7, 8	common		
9	output		

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
CGD982HCl	-	rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 × 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads	SOT115J

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _B	supply voltage		-	30	V
V _{i(RF)}	RF input voltage	single tone	-	75	dBmV
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM); According JEDEC standard 22-A114E	[1]	2000	V
		Biased; According IEC61000-4-2	-	1500	V
T _{stg}	storage temperature		-40	+100	°C
T _{mb}	mounting base temperature		-20	+100	°C

[1] The ESD pulse of 2000 V corresponds to a class 2 sensitivity level.

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5. Characteristics

Table 5. Characteristics

Bandwidth 40 MHz to 1003 MHz; $V_B = 24$ V (DC); $Z_S = Z_L = 75 \Omega$; $T_{mb} = 35$ °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
G_p	power gain	$f = 50$ MHz	-	21.5	-	dB
		$f = 870$ MHz	-	22.5	-	dB
		$f = 1003$ MHz	22	23	24	dB
SL_{sl}	slope straight line	$f = 40$ MHz to 1003 MHz	[1] 0.5	-	2	dB
FL	flatness of frequency response	$f = 40$ MHz to 1003 MHz	[2] -	-	1	dB
RL_{in}	input return loss	$f = 40$ MHz to 160 MHz	20	-	-	dB
		$f = 160$ MHz to 320 MHz	20	-	-	dB
		$f = 320$ MHz to 640 MHz	19	-	-	dB
		$f = 640$ MHz to 870 MHz	17	-	-	dB
		$f = 870$ MHz to 1003 MHz	16	-	-	dB
RL_{out}	output return loss	$f = 40$ MHz to 160 MHz	20	-	-	dB
		$f = 160$ MHz to 320 MHz	20	-	-	dB
		$f = 320$ MHz to 640 MHz	19	-	-	dB
		$f = 640$ MHz to 870 MHz	18	-	-	dB
		$f = 870$ MHz to 1003 MHz	17	-	-	dB
NF	noise figure	$f = 50$ MHz	-	4.6	5.6	dB
		$f = 1003$ MHz	-	5.5	6.5	dB
I_{tot}	total current		[3] -	440	460	mA

[1] G_p at 1003 MHz minus G_p at 40 MHz.

[2] Flatness is defined as peak deviation to straight line.

[3] Direct Current (DC).

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Table 6. Distortion characteristics

Bandwidth 40 MHz to 1003 MHz; $V_B = 24\text{ V (DC)}$; $Z_S = Z_L = 75\ \Omega$; $T_{mb} = 35\text{ }^\circ\text{C}$; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
98 PAL D channels						
CTB	composite triple beat	$V_o = 48\text{ dBmV at } 862\text{ MHz}$	[1]	-	-66	-62 dBc
		$V_o = 50\text{ dBmV at } 862\text{ MHz}$	[1]	-	-62	- dBc
CSO	composite second-order distortion	$V_o = 48\text{ dBmV at } 862\text{ MHz}$	[1]	-	-69	-62 dBc
		$V_o = 50\text{ dBmV at } 862\text{ MHz}$	[1]	-	-65	- dBc
Xmod	cross modulation	$V_o = 48\text{ dBmV at } 862\text{ MHz}$	[1]	-	-68	- dB
		$V_o = 50\text{ dBmV at } 862\text{ MHz}$	[1]	-	-60	- dB
112 NTSC channels						
CTB	composite triple beat	$V_o = 48\text{ dBmV at } 750\text{ MHz}$	[2]	-	-63	- dBc
CSO	composite second-order distortion	$V_o = 48\text{ dBmV at } 750\text{ MHz}$	[2]	-	-66	- dBc
Xmod	cross modulation	$V_o = 48\text{ dBmV at } 750\text{ MHz}$	[2]	-	-66	- dB
79 NTSC channels + 75 digital channels						
CTB	composite triple beat	$V_o = 56.4\text{ dBmV at } 1003\text{ MHz}$	[3]	-	-75	- dBc
CSO	composite second-order distortion	$V_o = 56.4\text{ dBmV at } 1003\text{ MHz}$	[3]	-	-77	- dBc
Xmod	cross modulation	$V_o = 56.4\text{ dBmV at } 1003\text{ MHz}$	[3]	-	-68	- dB
CCN	carrier-to-composite noise	$V_o = 56.4\text{ dBmV at } 1003\text{ MHz}$	[3]	-	57	- dBc

[1] 98 PAL D channels with 8 MHz bandwidth per channel; [f = 47 MHz to 862 MHz]; flat V_o till 862 MHz.

[2] 112 NTSC channels; [f = 45 MHz to 750 MHz]; flat V_o till 750 MHz.

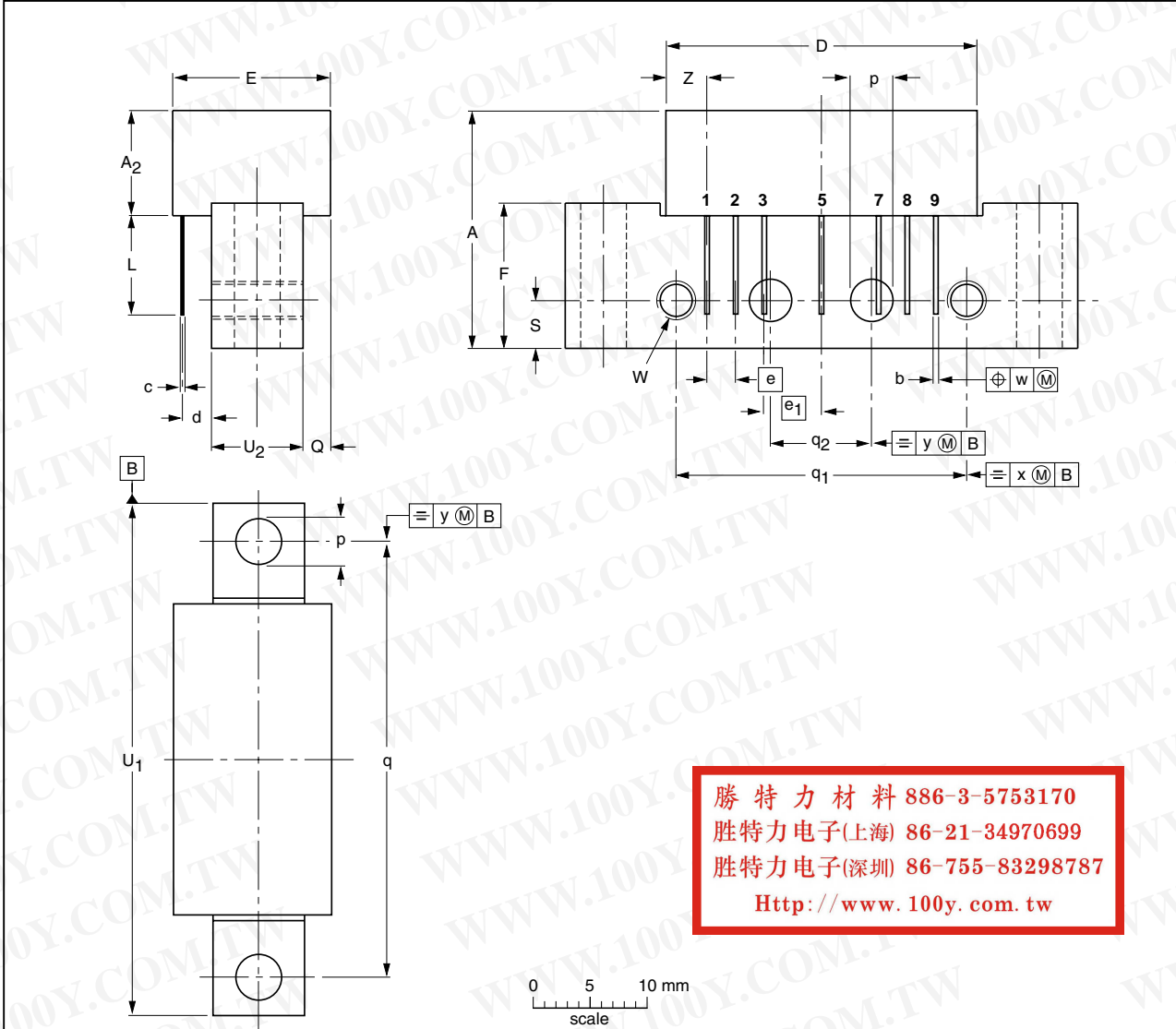
[3] 79 NTSC channels [f = 54 MHz to 550 MHz] + 75 digital channels [f = 550 MHz to 1003 MHz] (-6 dB offset); tilt extrapolated to 13.5 dB at 1003 MHz.

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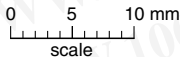
6. Package outline

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads

SOT115J



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DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₂ max.	b	c	D max.	d	E max.	e	e ₁	F	L min.	p	Q max.	q	q ₁	q ₂	S	U ₁	U ₂	W	w	x	y	Z max.
mm	20.8	9.5	0.51 0.38	0.25	27.2	2.04 2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75 44.25	8.2 7.8	6-32 UNC	0.25	0.7	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT115J						04-02-04 10-06-18

Fig 1. Package outline SOT115J

7. Abbreviations

Table 7. Abbreviations

Acronym	Description
CATV	Community Antenna TeleVision
ESD	ElectroStatic Discharge
GaAs	Gallium-Arsenide
NTSC	National Television Standard Committee
PAL D	Phase Alternate Line standard D
RF	Radio Frequency
UNC	UNified Coarse

8. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
CGD982HCl v.1	20110303	Product data sheet	-	-

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9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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